

MMBZ5245BWQ

200mW SURFACE MOUNT ZENER DIODE

Features

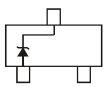
- Small Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)



Top View



Device Schematic

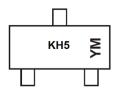
Ordering Information (Notes 4 & 5)

ĺ	Part Number	Qualification	Packaging	Shipping	
	MMBZ5245BWQ-7-F	Automotive	SOT323	3000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/product-compliance-definitions/
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



KH5 = Product Type Marking Code (See Electrical Characteristics Table) YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	2017	2018	20	19	2020	2021	2022	2023	20	24	2025	2026
Code	Е	F	(6	Н	I	J	K	L	_	M	N
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Cl	naracteristic	Symbol	Value	Unit
Forward Voltage	@ I _F = 10mA	V_{F}	0.9	V

Thermal Characteristics

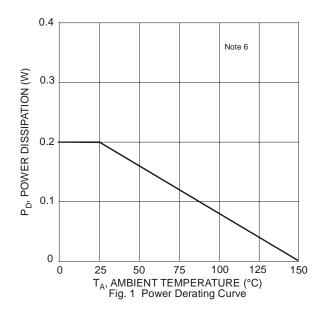
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +150	°C

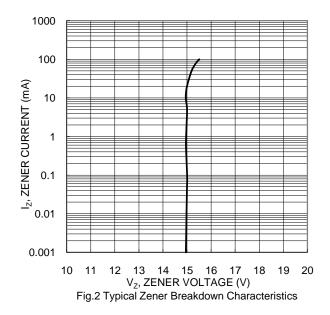
Notes: 6. Mounted on FR-4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com/package-outlines.html.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

T	Zener Voltage Range (Note 7)			Test Current	Maximum Zener Impedance (Note 8)		Maximum Reverse Leakage Current (Note 7)	
Type Number	V _Z @ I _{ZT}		I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK} = 0.25mA	I _R	@ V _R	
	Nom (V)	Min (V)	Max (V)	mA	2	Ω	μΑ	V
MMBZ5245BWQ	15	14.25	15.75	8.5	16	600	0.1	11

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. f = 1KHz.



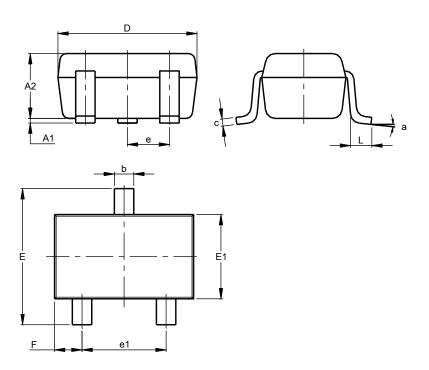




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

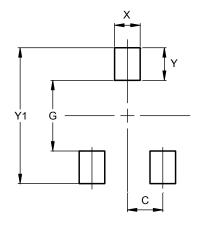


SOT323							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2 0.90		1.00	0.95				
b 0.25		0.40	0.30				
C	0.10	0.18	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	E1 1.15		1.30				
е	0.650 BSC						
e1	1.20	1.40	1.30				
F	0.375	0.475	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323



Dimensions	Value		
Dillielisions	(in mm)		
С	0.650		
G	1.300		
Х	0.470		
Y	0.600		
Y1	2.500		



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